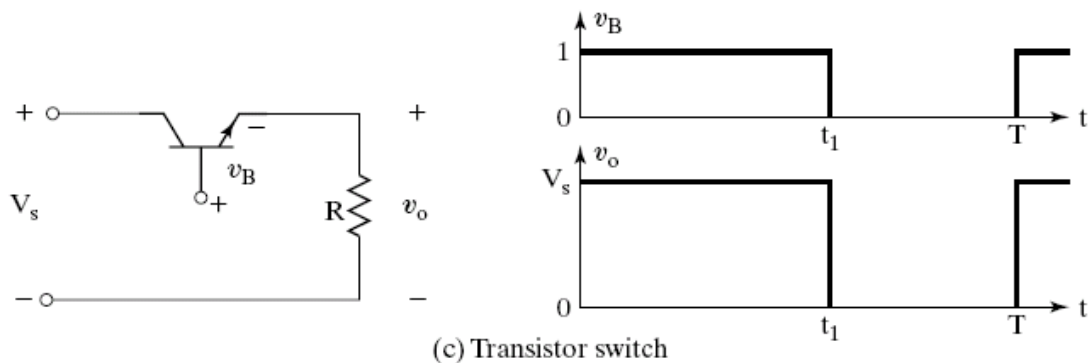
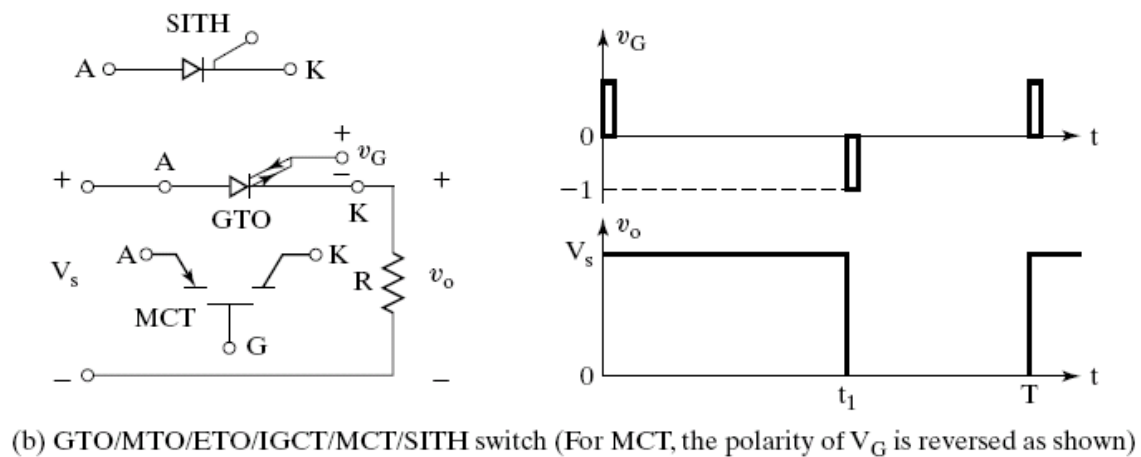
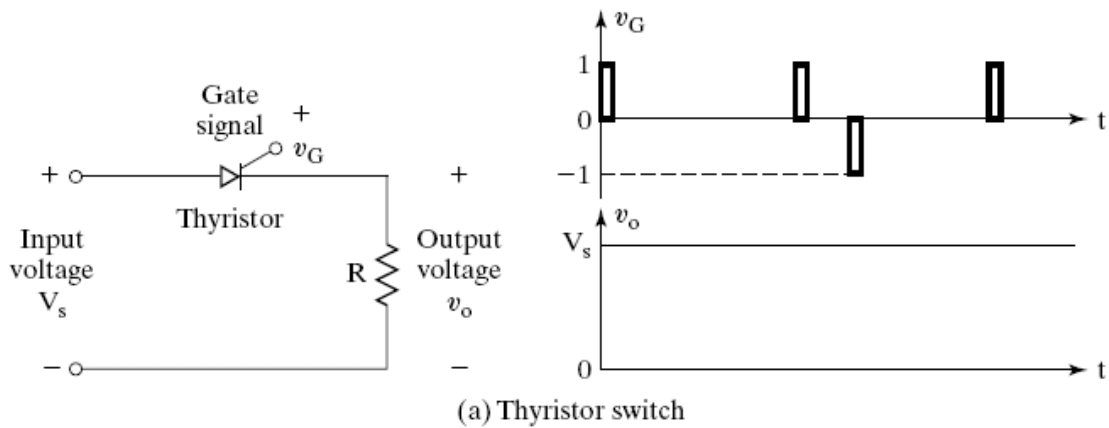


## CONTROL CHARACTERISTICS OF POWER DEVICES

The power semiconductor devices are used as switches. Depending on power requirements, ratings, fastness & control circuits for different devices can be selected. The required output is obtained by varying conduction time of these switching devices.

### Control characteristics of Thyristors:



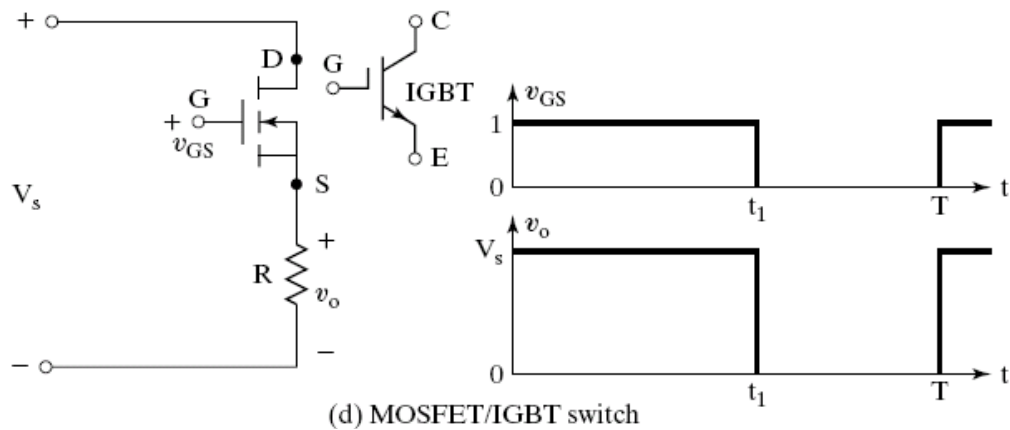


Fig1.3: Control Characteristics of Power Switching Devices

### Classification of power semiconductor devices:

- Uncontrolled turn on and turn off (e.g.: diode).
- Controlled turn on and uncontrolled turn off (e.g. SCR)
- Controlled turn on and off characteristics (e.g. BJT, MOSFET, GTO, SITH, IGBT, SIT, MCT).
- Continuous gate signal requirement (e.g. BJT, MOSFET, IGBT, SIT).
- Pulse gate requirement (e.g. SCR, GTO, MCT).
- Bipolar voltage withstanding capability (e.g. SCR, GTO).
- Unipolar voltage withstanding capability (e.g. BJT, MOSFET, GTO, IGBT, MCT).
- Bidirectional current capability (e.g.: Triac, RCT).
- Unidirectional current capability (e.g. SCR, GTO, BJT, MOSFET, MCT, IGBT, SITH, SIT & Diode).